

Buck Chopper with Field Stop Trench IGBT + SiC SBD



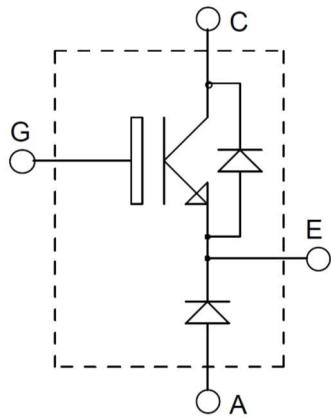
$V_{CES} = 1200V$
 $I_C = 30A @ T_C = 100^{\circ}C$

Features

- **Field StopTrench Fast IGBT**
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 50 kHz
 - Low leakage current
- **Chopper SiC Schottky Diode**
 - Zero reverse recovery current
 - Temperature Independent switching behavior
 - Positive temperature coefficient on VF

Applications

- Solar inverters
- AC and DC motor control
- Power Factor Correction
- Aerospace Actuators



Benefits

- Outstanding performance at high frequency operation
- Low switching losses
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive T_C of V_{CESat}
- RoHS Compliant

Absolute Maximum Ratings ($T_J=25^{\circ}C$ unless otherwise specified)

Parameters	Symbol	Conditions	Specifications	Units
Collector - Emitter Breakdown Voltage	V_{CES}		1200	V
Continuous Collector Current	I_C	$T_C = 25^{\circ}C$	60	A
		$T_C = 100^{\circ}C$	30	A
Gate-Emitter Voltage	V_{GES}		± 20	V
Pulsed Collector Current	ICM		90	A
Maximum Power Dissipation	P_D	$T_C = 25^{\circ}C$	340	W
		$T_C = 100^{\circ}C$	140	W
Operating Junction Temperature	T_J		-55 ~ 150	$^{\circ}C$
Storage Temperature	T_{STG}		-55 ~ 150	$^{\circ}C$

Electrical Characteristics (T_j=25°C unless otherwise specified)

Parameters	Symbol	Conditions	Min	Typ	Max	Units
OFF						
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} = 1200V, V _{GE} = 0V	--	--	1	mA
Gate-Emitter Leakage Current	I _{GES}	V _{CE} = 0V, V _{GE} = 20V	--	--	±250	nA
ON						
Gate-Emitter Threshold Voltage	V _{GE(TH)}	V _{GE} = V _{CE} , I _C = 30mA	3.5	5.5	7.5	V
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	V _{CE} = 15V, I _C = 30A, T _j = 25 °C	--	2.0	2.5	V
		V _{CE} = 15V, I _C = 30A, T _j = 125 °C	--	2.3	--	V
DYNAMIC						
Input Capacitance	C _{IES}	V _{CE} = 30V, V _{GE} = 0V, f = 1 MHz	--	4000	--	pF
Output Capacitance	C _{OES}		--	105	--	pF
Reverse Transfer Capacitance	C _{RES}		--	72	--	pF
SWITCHING						
Turn-On Delay Time	t _{d(on)}	V _{CE} = 600V, I _C = 30A R _G = 10Ω, V _{GE} = 15V Inductive Load, T _j = 25 °C	--	40	--	ns
Rise Time	t _r		--	50	--	ns
Turn-Off Delay Time	t _{d(off)}		--	245	--	ns
Fall Time	t _f		--	70	--	ns
Turn-On Switching Energy Loss	E _{ON}		--	3.5	--	mJ
Turn-Off Switching Energy Loss	E _{OFF}		--	0.85	--	mJ
Turn-On Delay Time	t _{d(on)}	V _{CE} = 600V, I _C = 30A R _G = 10Ω, V _{GE} = 15V Inductive Load, T _j = 125 °C	--	34	--	ns
Rise Time	t _r		--	27	--	ns
Turn-Off Delay Time	t _{d(off)}		--	256	--	ns
Fall Time	t _f		--	142	--	ns
Turn-On Switching Energy Loss	E _{ON}		--	3.87	--	mJ
Turn-Off Switching Energy Loss	E _{OFF}		--	1.8	--	mJ
Total Gate Charge	Q _g	V _{CE} = 600V, I _C = 30A V _{GE} = 15V	--	170	255	nC
Gate-Emitter Charge	Q _{ge}		--	27	41	nC
Gate-Collector Charge	Q _{gc}		--	60	90	nC
Short Circuit Withstanding Time	t _{sc}	V _{CE} = 600V, V _{GE} = 15V T _j = 125 °C	10	--	--	μs

SiC Diode Rating and Characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified)

Parameters	Symbol	Conditions	Min	Typ	Max	Units
Maximum peak repetitive reverse voltage	V_{RRM}		1200	--	--	V
Maximum Reverse Leakage Current	I_{RM}	$V_R = 1200\text{V}, T_j = 25^\circ\text{C}$	--	4.1	100	μA
		$V_R = 1200\text{V}, T_j = 150^\circ\text{C}$	--	606		μA
Diode Forward Voltage	V_F	$I_F = 15\text{A}, T_j = 25^\circ\text{C}$	--	1.5	1.7	V
		$I_F = 15\text{A}, T_j = 150^\circ\text{C}$	--	2.3	--	V
Total Capacitive Charge	Q_C	$VR=1200\text{ V}, IF < IF_{max}$	--	52	--	nC
Switching Time	t_C	$dI_F/dt = 200\text{ A}/\mu\text{s}, T_j = 175^\circ\text{C}$	--	--	10	ns
Total Capacitance	C	$V_R = 1\text{V}, f = 1\text{ MHz}$	--	895	--	pF
		$V_R = 600\text{V}, f = 1\text{ MHz}$	--	52	--	pF
		$V_R = 1200\text{V}, f = 1\text{ MHz}$	--	43	--	pF

Thermal and Package Characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified)

Parameters	Symbol	Conditions	Min	Typ	Max	Units
Junction to Case Thermal Resistance	R_{THJC}	IGBT chip	--	--	0.35	$^\circ\text{C}/\text{W}$
		SiC SBD chip	--	--	0.65	$^\circ\text{C}/\text{W}$
Mounting Torque	M_d				1.5	N-m
Terminal Connection Torque	M_{dt}		1.3	--	1.5	N-m
Package Weight	W_t			29		g
Isolation Voltage	V_{ISOL}	$I_{ISOL} < 1\text{mA}, 50/60\text{ Hz}, t=1\text{ min}$	2500	V		

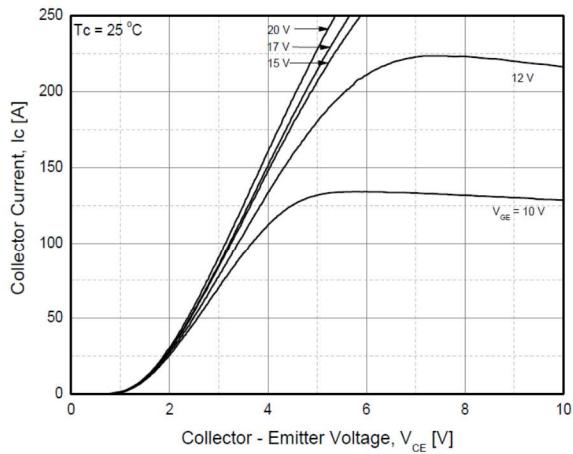
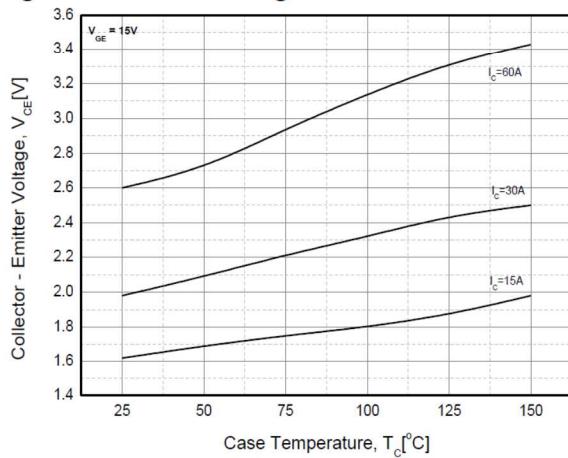
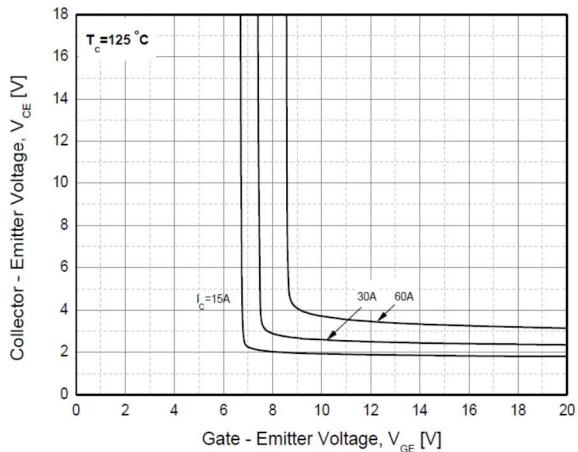
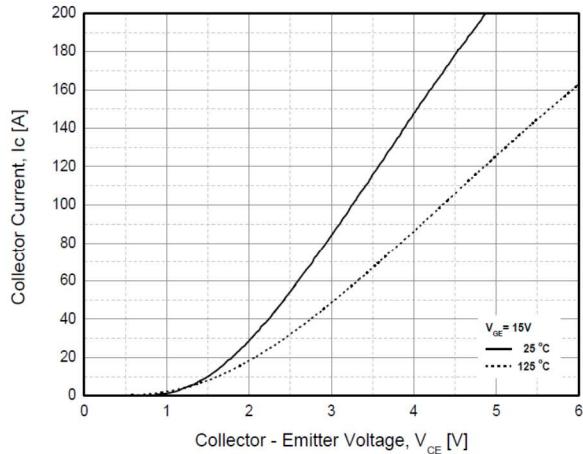
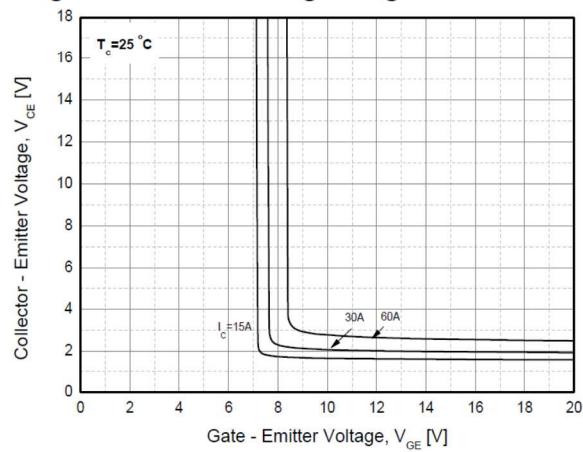
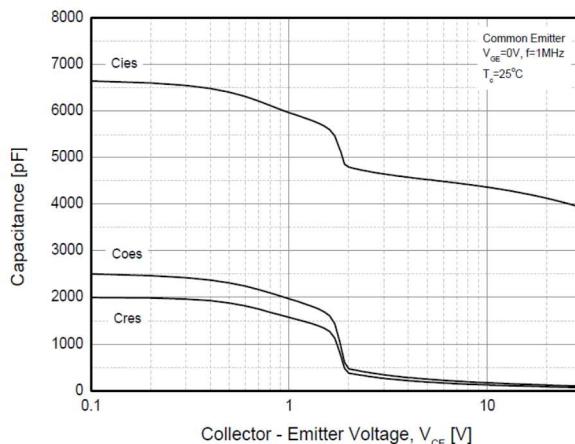
IGBT Characteristics
Fig. 1 Output characteristics

Fig. 3 Saturation voltage vs. collector current

Fig. 5 Saturation voltage vs. gate bias

Fig. 2 Saturation voltage characteristics

Fig. 4 Saturation voltage vs. gate bias

Fig. 6 Capacitance characteristics


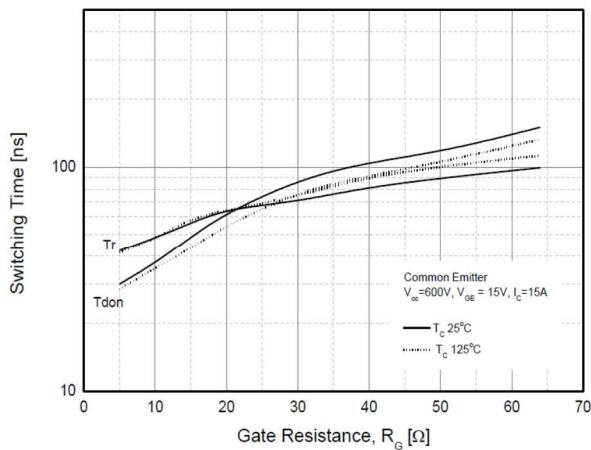
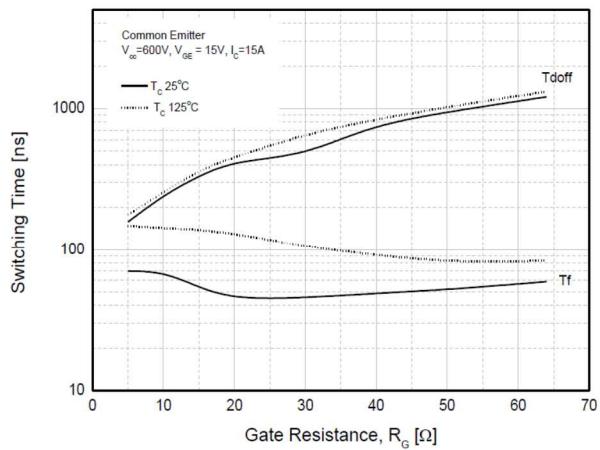
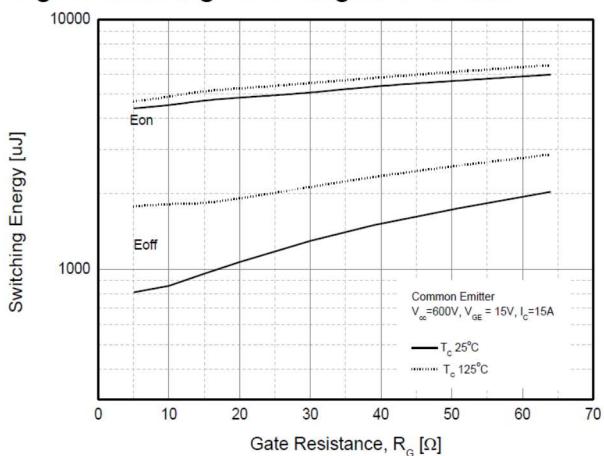
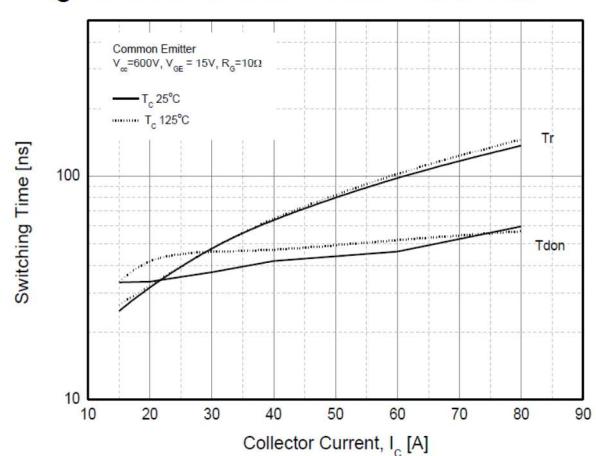
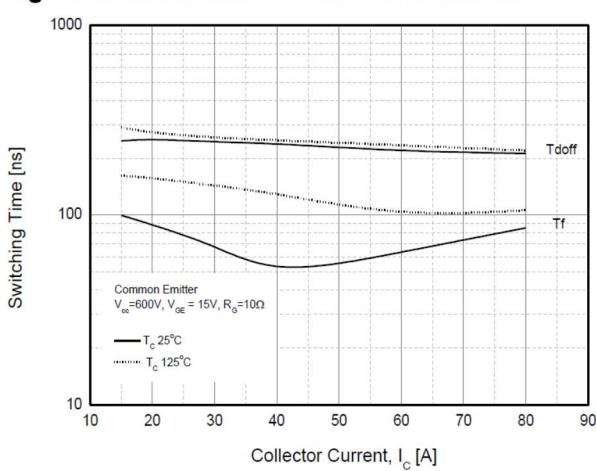
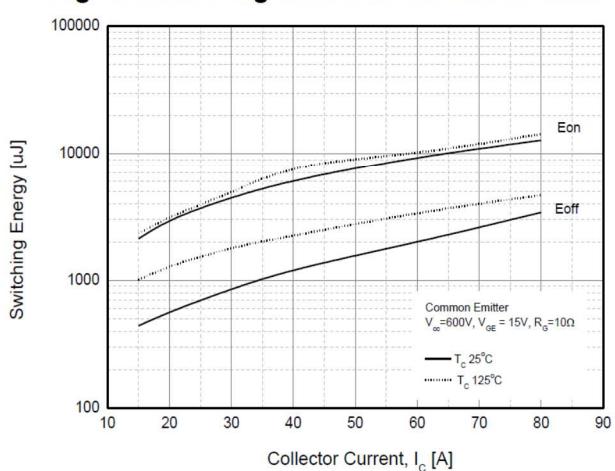
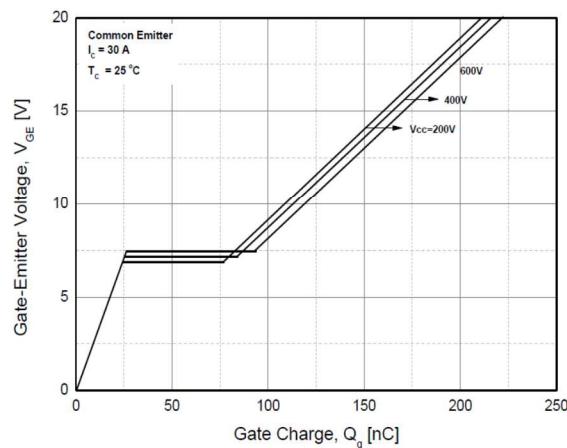
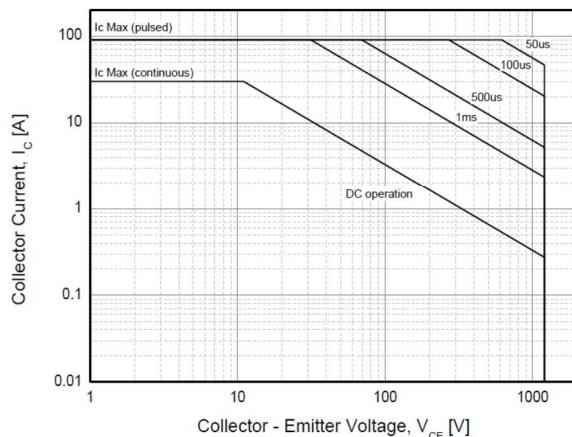
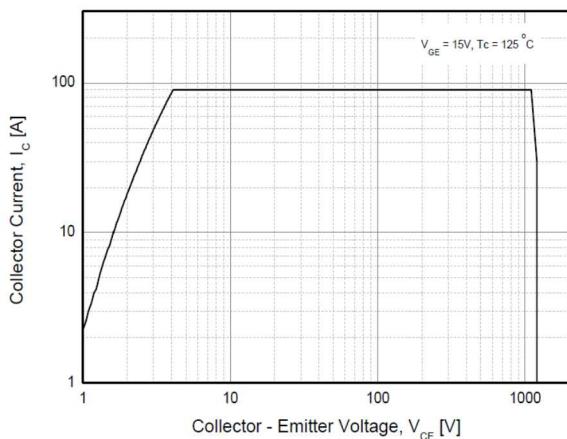
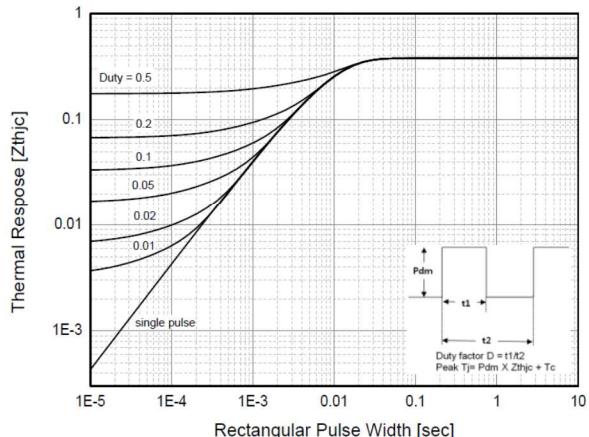
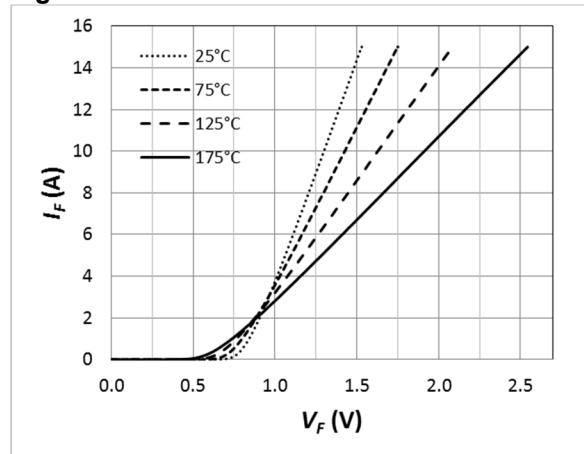
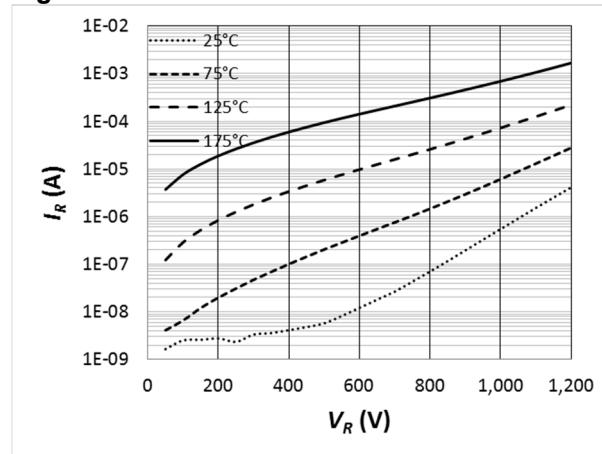
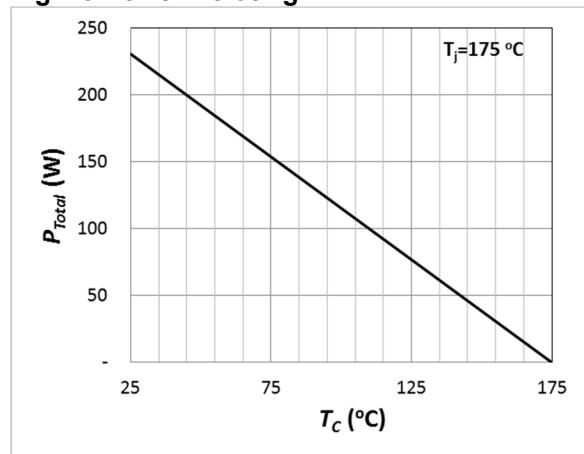
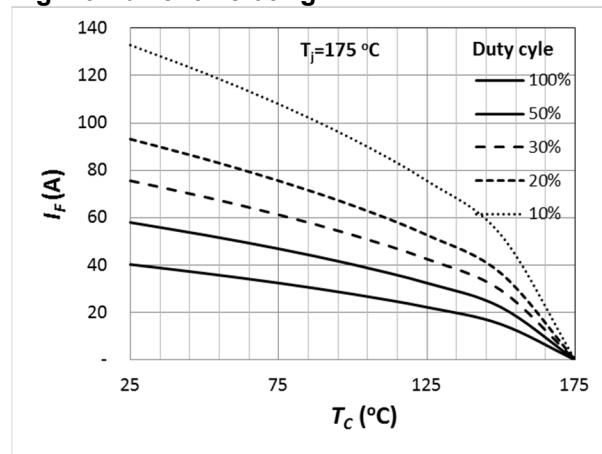
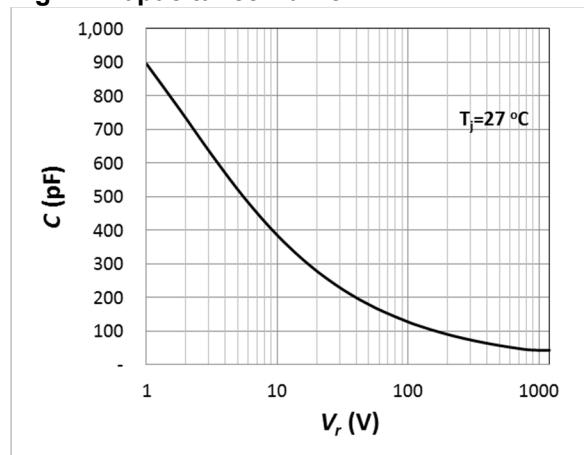
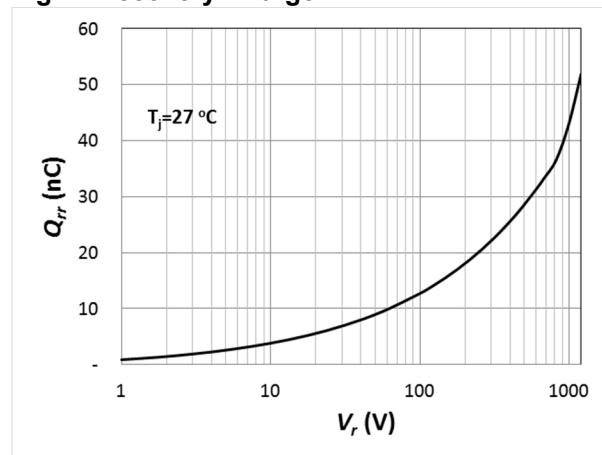
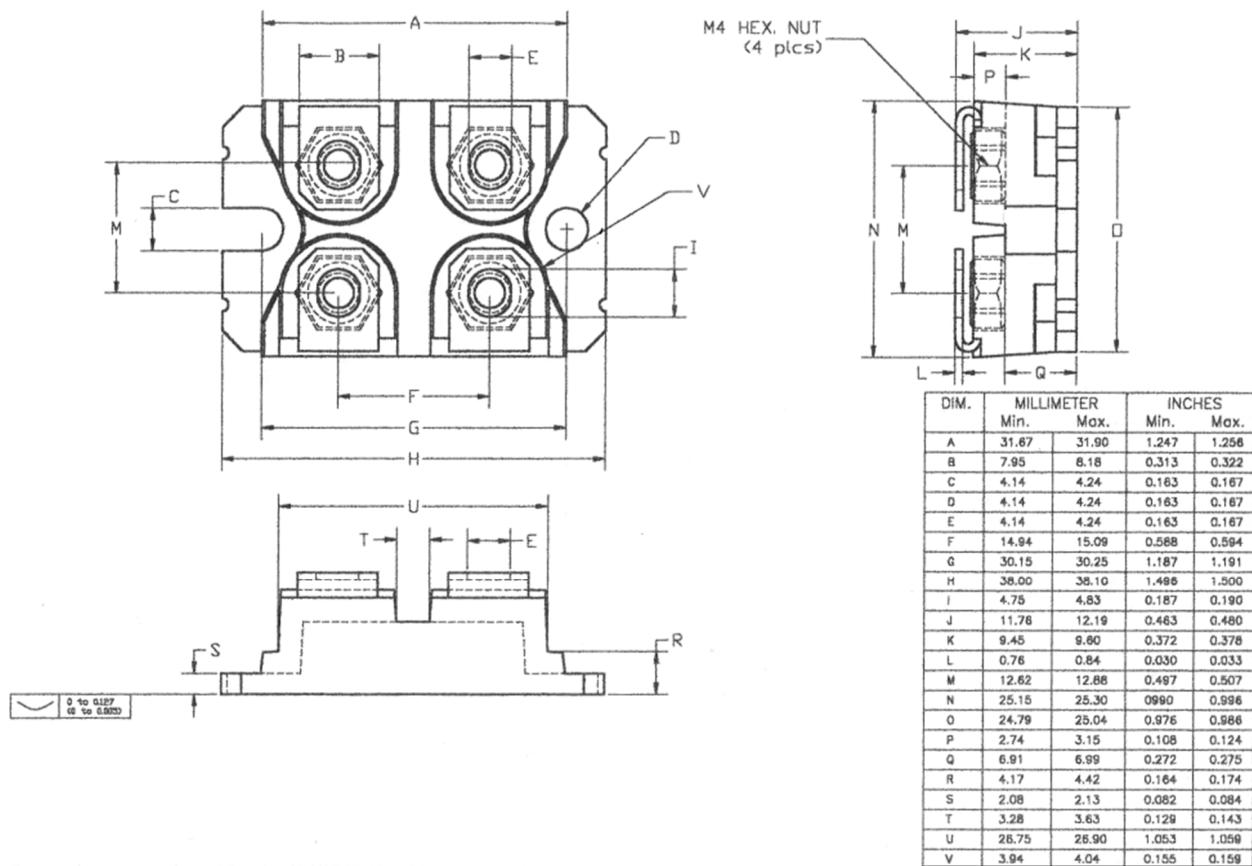
Fig. 7 Turn on time vs. gate resistance

Fig. 8 Turn off time vs. gate resistance

Fig. 9 Switching loss vs. gate resistance

Fig. 10 Turn on time vs. collector current

Fig. 11 Turn off time vs. collector current

Fig. 12 Switching loss vs. collector current


Fig. 13 Gate charge characteristics

Fig. 14 SOA

Fig. 15 RBSOA

Fig. 16 Transient thermal impedance


Buck SiC Diode Characteristics
Fig. 17 Forward Characteristics

Fig. 18 Reverse Characteristics

Fig. 19 Power Derating

Fig. 20 Current Derating

Fig. 21 Capacitance Curve

Fig. 22 Recovery Charge


SOT-227 Package Outline

Revision History

Date	Revision	Notes
6/3/2014	1.0	Initial release
8/2/2018	1.1	Correct the typo in the pin assignment

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Notes

- **RoHS Compliance**
The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.gptechgroup.com.
- **REACh Compliance**
REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at GPTG Headquarters in Lake Forest, California to insure you get the most up-to-date REACh SVHC Declaration.
REACh banned substance information (REACh Article 67) is also available upon request.
- This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control.
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